

RSP2512FW1

FPM1 PIM

1200V 25A, IGBT Module



Electrical Features

- Trench Field Stop IGBT
- Very low $V_{CE(sat)}$
- Extremely low switching losses

Mechanical Features

- Very Low Thermal Resistance with DBC Substrate
- High power density
- Compact design
- Isolation Rating of 2500 Vrms/1 min



Typical Applications

- Auxiliary inverters
- Air-conditioner
- Motor drives

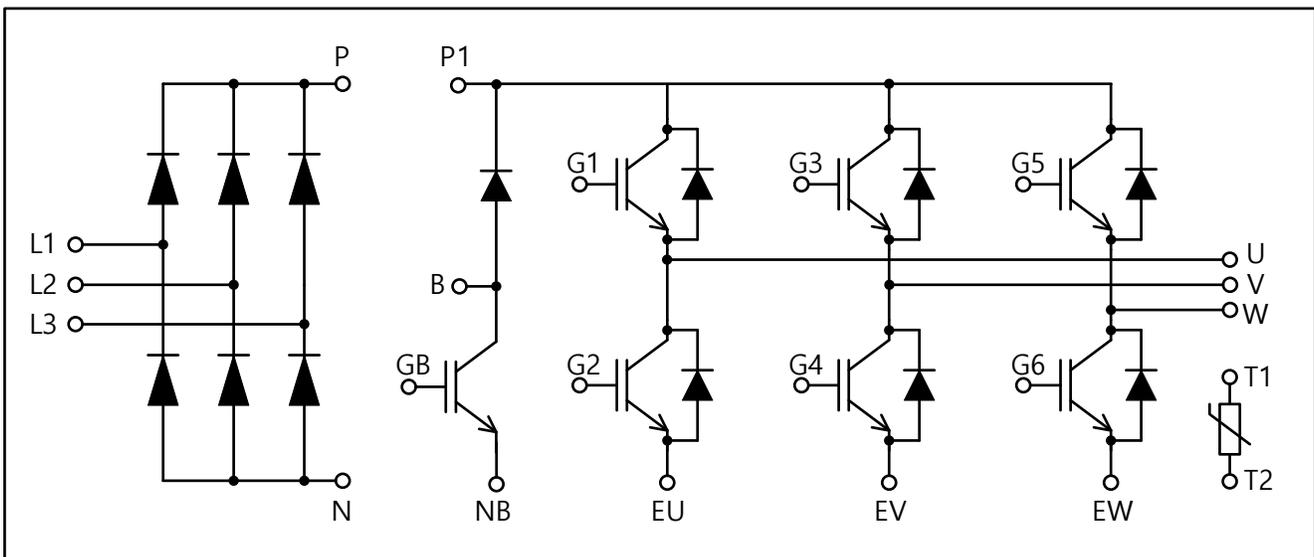


Figure 1. Internal Circuit

ABSOLUTE MAXIMUM RATINGS ($T_j = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Rating	Unit
IGBT, INVERTER				
V_{CES}	Collector-Emitter Voltage		1200	V
V_{GES}	Gate-Emitter Voltage		± 20	V
I_C	DC Collector Current	$T_C=100^\circ\text{C}, T_j \leq 175^\circ\text{C}$	25	A
I_{CRM}	Repetitive Peak Collector Current	Under 1ms Pulse Width	50	A

Diode, INVERTER

V_{RRM}	Repetitive Peak Reverse Voltage		1200	V
I_F	DC Forward Current		25	A
I_{FRM}	Repetitive Peak Forward Current	Under 1ms Pulse Width	50	A
I^2t	I^2t Value	$t_p=10\text{ms}, T_j=150^\circ\text{C}$	98	A^2s

IGBT, Brake-Chopper

V_{CES}	Collector-Emitter Voltage		1200	V
V_{GES}	Gate-Emitter Voltage		± 20	V
I_C	DC Collector Current	$T_C=100^\circ\text{C}, T_j \leq 175^\circ\text{C}$	25	A
I_{CRM}	Repetitive Peak Collector Current	Under 1ms Pulse Width	50	A

Diode, Brake-Chopper

V_{RRM}	Repetitive Peak Reverse Voltage		1200	V
I_F	DC Forward Current		10	A
I_{FRM}	Repetitive Peak Forward Current	Under 1ms Pulse Width	20	A
I^2t	I^2t Value	$V_R=0\text{V}, t_p=10\text{ms}, T_j=150^\circ\text{C}$	18	A^2s

Diode, Rectifier

V_{RRM}	Repetitive Peak Reverse Voltage		1600	V
I_{FRMSM}	Maximum RMS Forward Current per Chip	$T_C=100^\circ\text{C}$	25	A
I_{RMSM}	Maximum RMS Forward Current at Rectifier Output	$T_C=100^\circ\text{C}$	25	A
I_{FSM}	Surge Forward Current	$t_p=10\text{ms}, T_j=150^\circ\text{C}$	210	A
I^2t	I^2t Value	$t_p=10\text{ms}, T_j=150^\circ\text{C}$	220	A^2s

ELECTRICAL CHARACTERISTICS ($T_j = 25^\circ\text{C}$ unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
IGBT, INVERTER						
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C=25\text{A}, V_{GE}=15\text{V}$	$T_j=25^\circ\text{C}$	1.60	1.9	V
			$T_j=125^\circ\text{C}$	1.75		
			$T_j=175^\circ\text{C}$	1.83		
$V_{GE(th)}$	Gate Threshold Voltage	$I_C=250\mu\text{A}, V_{CE}=V_{GE}$	5.0	5.8	6.6	V
I_{CES}	Collector-Emitter Cut-off Current	$V_{CE}=1200\text{V}, V_{GE}=0\text{V}$			2.0	μA
I_{GES}	Gate Leakage Current	$V_{CE}=0\text{V}, V_{GE}=20\text{V}$			100	nA
Q_G	Total Gate Charge	$V_{GE}=\pm 15\text{V}, V_{CE}=600\text{V}$		0.126		μC
R_{Gint}	Internal Gate Resistance			0		Ω
C_{ies}	Input Capacitance	$V_{CE}=30\text{V}, V_{GE}=0\text{V}, f=1.0\text{MHz}$		2345		pF
C_{oes}	Output Capacitance			70		
C_{res}	Reverse Transfer Capacitance			10.7		

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
IGBT, INVERTER (Continued)						
t_{don}	Turn-on Delay Time	$V_{CE}=600V, I_C=25A,$ $V_{GE}=0/15V,$ $R_{G_ON}=6\Omega, R_{G_OFF}=6\Omega$	$T_J=25^\circ C$	36		ns
			$T_J=125^\circ C$	36		
			$T_J=175^\circ C$	37		
t_r	Rise Time	$V_{CE}=600V, I_C=25A,$ $V_{GE}=0/15V,$ $R_{G_ON}=6\Omega, R_{G_OFF}=6\Omega$	$T_J=25^\circ C$	16		ns
			$T_J=125^\circ C$	18		
			$T_J=175^\circ C$	19		
t_{doff}	Turn-off Delay Time	$V_{CE}=600V, I_C=25A,$ $V_{GE}=0/15V,$ $R_{G_ON}=6\Omega, R_{G_OFF}=6\Omega$	$T_J=25^\circ C$	163		ns
			$T_J=125^\circ C$	196		
			$T_J=175^\circ C$	217		
t_f	Fall Time	$V_{CE}=600V, I_C=25A,$ $V_{GE}=0/15V,$ $R_{G_ON}=6\Omega, R_{G_OFF}=6\Omega$	$T_J=25^\circ C$	152		ns
			$T_J=125^\circ C$	259		
			$T_J=175^\circ C$	323		
E_{on}	Turn-on Energy Loss per Pulse	$V_{CE}=600V, I_C=25A,$ $V_{GE}=0/15V,$ $R_{G_ON}=6\Omega, R_{G_OFF}=6\Omega$	$T_J=25^\circ C$	1.06		mJ
			$T_J=125^\circ C$	1.41		
			$T_J=175^\circ C$	1.76		
E_{off}	Turn-off Energy Loss per Pulse	$V_{CE}=600V, I_C=25A,$ $V_{GE}=0/15V,$ $R_{G_ON}=6\Omega, R_{G_OFF}=6\Omega$	$T_J=25^\circ C$	1.49		mJ
			$T_J=125^\circ C$	2.22		
			$T_J=175^\circ C$	2.65		
I_{SC}	Short-circuit Current	$V_{CC}=600V, V_{GE}\leq 15V, V_{CEmax}\leq 1200V, T_J=150^\circ C$ $t_p\leq 10\mu s$		74		A
R_{thJC}	Thermal Resistance, Junction to Case	Per IGBT		1.5		$^\circ C/W$
T_{Jop}	Temperature under Switching Conditions		-40		175	$^\circ C$

Diode, INVERTER

V_F	Forward Voltage	$I_F=25A, V_{GE}=0V$	$T_J=25^\circ C$	1.80	2.1	V
			$T_J=125^\circ C$	1.95		
			$T_J=175^\circ C$	1.96		
I_{RM}	Peak Reverse Recovery Current	$V_R=600V, I_F=25A,$ $V_{GE}=0V, R_G=6\Omega$	$T_J=25^\circ C$	40.7		A
			$T_J=125^\circ C$	43.0		
			$T_J=175^\circ C$	42.9		
t_{rr}	Reverse Recovery Time	$V_R=600V, I_F=25A,$ $V_{GE}=0V, R_G=6\Omega$	$T_J=25^\circ C$	202		ns
			$T_J=125^\circ C$	322		
			$T_J=175^\circ C$	412		
Q_r	Recovered Charge	$V_R=600V, I_F=25A,$ $V_{GE}=0V, R_G=6\Omega$	$T_J=25^\circ C$	2.02		uC
			$T_J=125^\circ C$	2.95		
			$T_J=175^\circ C$	3.89		
E_{rec}	Reverse Recovery Energy	$V_R=600V, I_F=25A,$ $V_{GE}=0V, R_G=6\Omega$	$T_J=25^\circ C$	0.43		mJ
			$T_J=125^\circ C$	0.58		
			$T_J=175^\circ C$	0.75		
R_{thJC}	Thermal Resistance, Junction to Case	Per Diode		2.0		$^\circ C/W$
T_{Jop}	Temperature under Switching Conditions		-40		175	$^\circ C$

ELECTRICAL CHARACTERISTICS (T_j = 25°C unless otherwise specified.) (continued)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
IGBT, Brake-Chopper						
V _{CE(sat)}	Collector-Emitter Saturation Voltage	I _C =25A, V _{GE} =15V	T _j =25°C	1.60	1.9	V
			T _j =125°C	1.75		
			T _j =175°C	1.83		
V _{GEth}	Gate Threshold Voltage	I _C =250uA, V _{CE} =V _{GE}	5.0	5.8	6.6	V
I _{CES}	Collector-Emitter Cut-off Current	V _{CE} =1200V, V _{GE} =0V			2.0	uA
I _{GES}	Gate Leakage Current	V _{CE} =0V, V _{GE} =20V			100	nA
Q _G	Total Gate Charge	V _{GE} =±15V, V _{CE} =600V		0.126		uC
R _{Gint}	Internal Gate Resistance			0		Ω
C _{ies}	Input Capacitance	V _{CE} =30V, V _{GE} =0V, f=1.0MHz		2345		pF
C _{oes}	Output Capacitance			70		
C _{res}	Reverse Transfer Capacitance			10.7		
t _{don}	Turn-on Delay Time	V _{CE} =600V, I _C =25A, V _{GE} =0/15V, R _{G_ON} =10Ω, R _{G_OFF} =10Ω	T _j =25°C	76		ns
			T _j =125°C	77		
			T _j =175°C	78		
t _r	Rise Time	V _{CE} =600V, I _C =25A, V _{GE} =0/15V, R _{G_ON} =10Ω, R _{G_OFF} =10Ω	T _j =25°C	41		ns
			T _j =125°C	49		
			T _j =175°C	53		
t _{doff}	Turn-off Delay Time	V _{CE} =600V, I _C =25A, V _{GE} =0/15V, R _{G_ON} =10Ω, R _{G_OFF} =10Ω	T _j =25°C	177		ns
			T _j =125°C	209		
			T _j =175°C	224		
t _f	Fall Time	V _{CE} =600V, I _C =25A, V _{GE} =0/15V, R _{G_ON} =10Ω, R _{G_OFF} =10Ω	T _j =25°C	149		ns
			T _j =125°C	245		
			T _j =175°C	303		
E _{on}	Turn-on Energy Loss per Pulse	V _{CE} =600V, I _C =25A, V _{GE} =0/15V, R _{G_ON} =10Ω, R _{G_OFF} =10Ω	T _j =25°C	1.82		mJ
			T _j =125°C	2.28		
			T _j =175°C	2.56		
E _{off}	Turn-off Energy Loss per Pulse	V _{CE} =600V, I _C =25A, V _{GE} =0/15V, R _{G_ON} =10Ω, R _{G_OFF} =10Ω	T _j =25°C	1.53		mJ
			T _j =125°C	2.22		
			T _j =175°C	2.57		
I _{SC}	Short-circuit Current	V _{CC} =600V, V _{GE} ≤15V, V _{CEmax} ≤1200V, T _j =150°C, t _p ≤10us		74		A
R _{thJC}	Thermal Resistance, Junction to Case	Per IGBT		1.5		°C/W
T _{jop}	Temperature under Switching Conditions		-40		175	°C

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified.) (continued)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Diode, Brake-Chopper						
V _F	Forward Voltage	I _F =10A, V _{GE} =0V	T _J =25°C	1.80	2.1	V
			T _J =125°C	1.91		
			T _J =175°C	1.89		
I _{RM}	Peak Reverse Recovery Current	V _R =600V, I _F =10A, V _{GE} =0V, R _G =10Ω	T _J =25°C	11.24		A
			T _J =125°C	10.61		
			T _J =175°C	10.97		
t _{rr}	Reverse Recovery Time	V _R =600V, I _F =10A, V _{GE} =0V, R _G =10Ω	T _J =25°C	173		ns
			T _J =125°C	264		
			T _J =175°C	360		
Q _r	Recovered Charge	V _R =600V, I _F =10A, V _{GE} =0V, R _G =10Ω	T _J =25°C	0.636		uC
			T _J =125°C	0.997		
			T _J =175°C	1.325		
E _{rec}	Reverse Recovery Energy	V _R =600V, I _F =10A, V _{GE} =0V, R _G =10Ω	T _J =25°C	0.171		mJ
			T _J =125°C	0.226		
			T _J =175°C	0.271		
R _{thJC}	Thermal Resistance, Junction to Case	Per Diode		2.3		°C/W
T _{jop}	Temperature under Switching Conditions		-40		175	°C

Diode, Rectifier

V _F	Forward Voltage	I _F =10A, T _J =150°C		1.1		V
I _r	Reverse Current	V _R =1600V, T _J =150°C		1		mA
R _{thJC}	Thermal Resistance, Junction to Case	Per Diode		1.5		°C/W
T _{jop}	Temperature under Switching Conditions		-40		175	°C

NTC-Thermistor

R ₂₅	Rated Resistance	T _{NTC} =25°C	4.85	5	5.15	kΩ
ΔR/R	Deviation of R100	T _C =100°C, R ₁₀₀ =490Ω	-5		5	%
P ₂₅	Power Dissipation	T _{NTC} =25°C			60	mW
B _{25/50}	B-constant	R ₂ =R ₂₅ exp[B _{25/50} (1/T ₂ -1/(298.15K))]		3375		K
B _{25/80}	B-constant	R ₂ =R ₂₅ exp[B _{25/80} (1/T ₂ -1/(298.15K))]		3425		K
B _{25/100}	B-constant	R ₂ =R ₂₅ exp[B _{25/100} (1/T ₂ -1/(298.15K))]		3443		K

Package

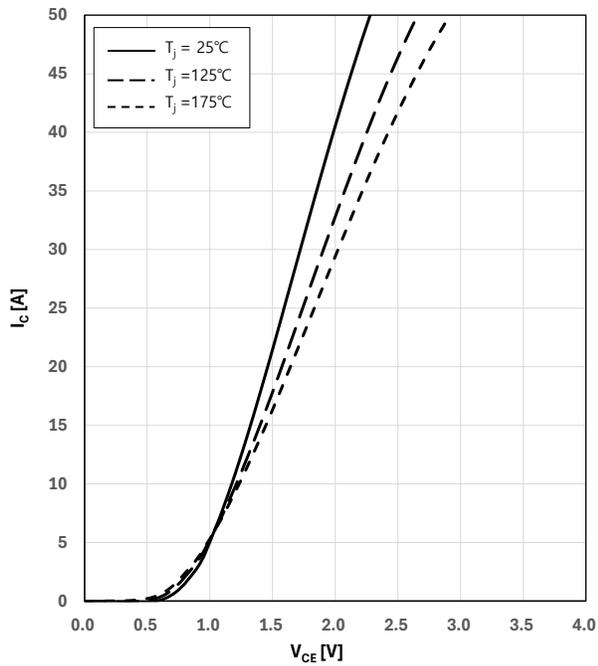
Symbol	Parameter	Conditions	Rating	Unit
V _{ISO}	Isolation Test Voltage	RMS, f=50Hz, t=1min	2500	V
d _{creep}	Creepage Distance	Terminal to Heatsink	11.5	mm
		Terminal to Terminal	6.3	mm
d _{clear}	Clearance	Terminal to Heatsink	10.0	mm
		Terminal to Terminal	5.0	mm
CTI	Comparative Tracking Index		>200	-

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
T _{stg}	Storage Temperature		-40		125	°C
G	Weight			22		g
F	Mounting Force per Clamp		20		50	N

CHARACTERISTICS DIAGRAMS

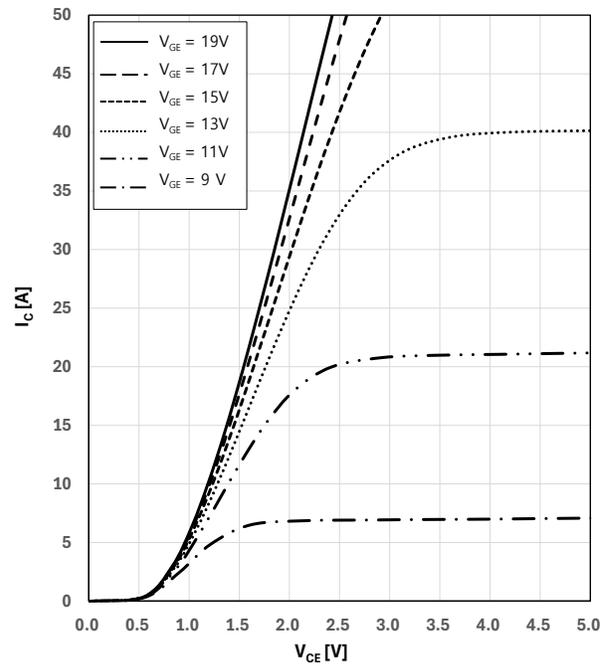
Output characteristic (typical), IGBT, Inverter

$I_C=f(V_{CE})$
 $V_{GE}=15V$



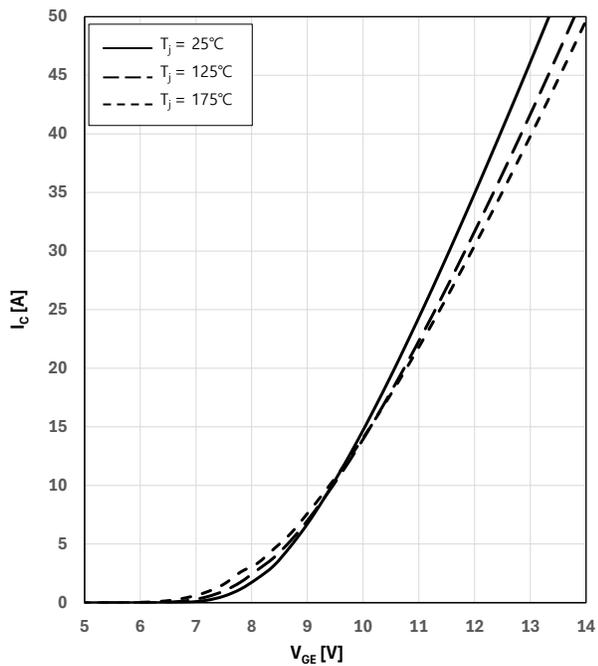
Output characteristic (typical), IGBT, Inverter

$I_C=f(V_{CE})$
 $T_j=175^\circ C$



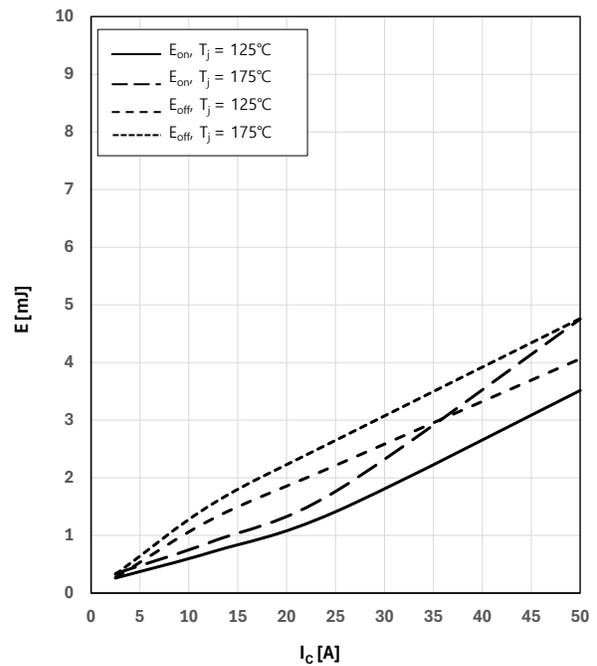
Transfer characteristic (typical), IGBT, Inverter

$I_C=f(V_{GE})$
 $V_{CE}=20V$



Switching losses (typical), IGBT, Inverter

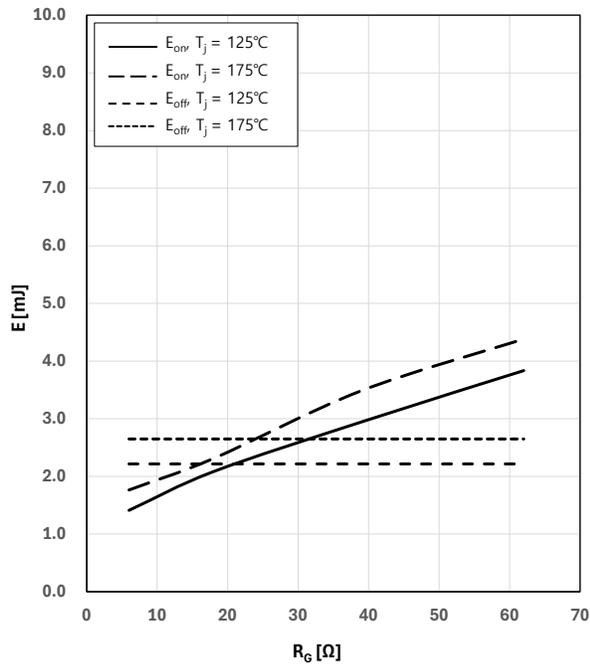
$E=f(I_C)$
 $R_{Goff}=6\Omega, R_{Gon}=6\Omega, V_{CE}=600V, V_{GE}=\pm 15V$



Switching losses (typical), IGBT, Inverter

$E=f(R_G)$

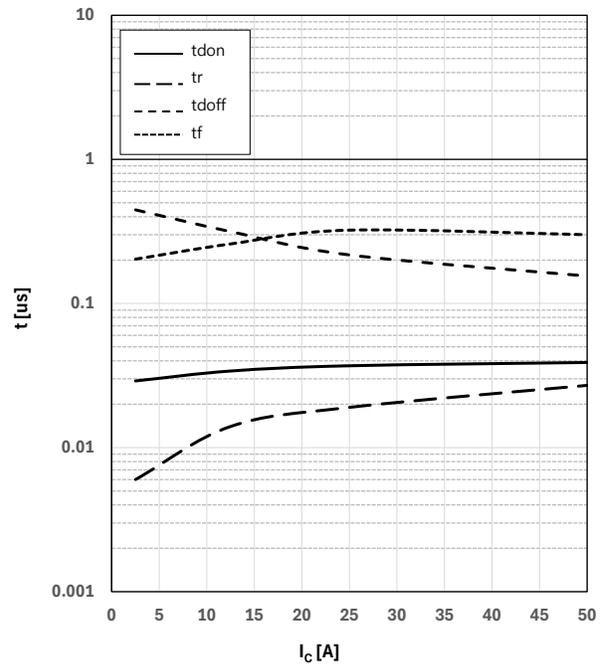
$I_C=25A, V_{CE}=600V, V_{GE}=\pm 15V$



Switching times (typical), IGBT, Inverter

$t=f(I_C)$

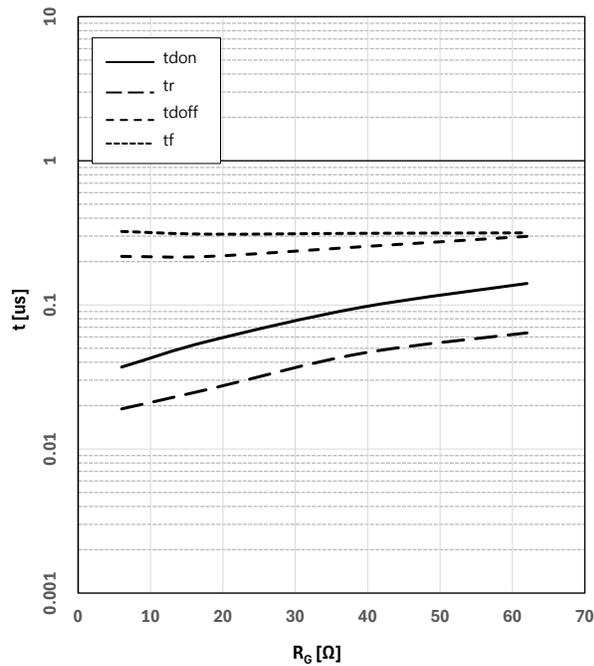
$R_{Goff}=6Ω, R_{Gon}=6Ω, V_{CE}=600V, V_{GE}=\pm 15V, T_j=175°C$



Switching times (typical), IGBT, Inverter

$t=f(R_G)$

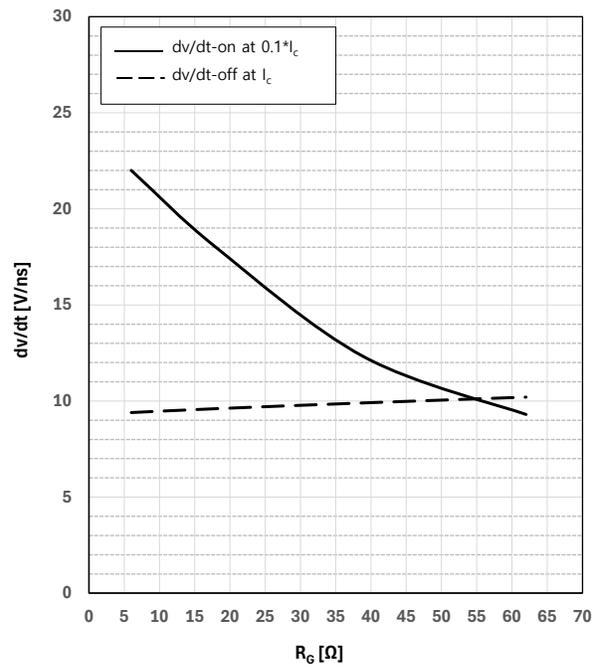
$I_C=25A, V_{CE}=600V, V_{GE}=\pm 15V, T_j=175°C$



dv/dt (typical), IGBT, Inverter

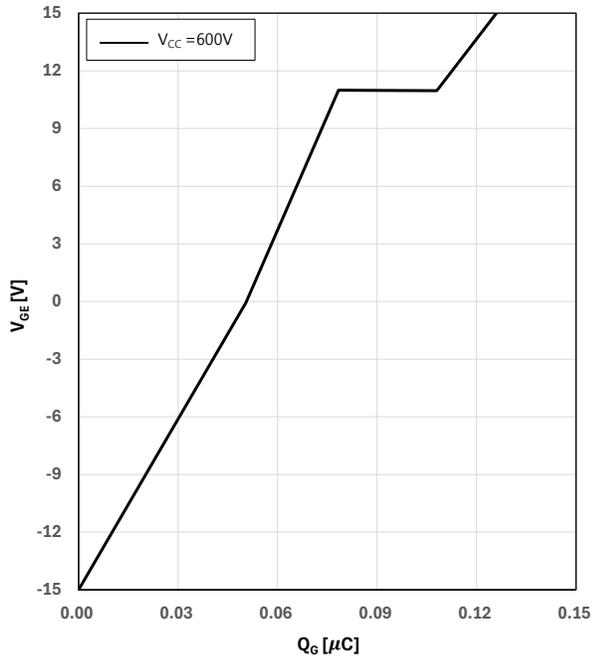
$dv/dt=f(R_G)$

$I_C=25A, V_{CE}=600V, V_{GE}=\pm 15V, T_j=25°C$



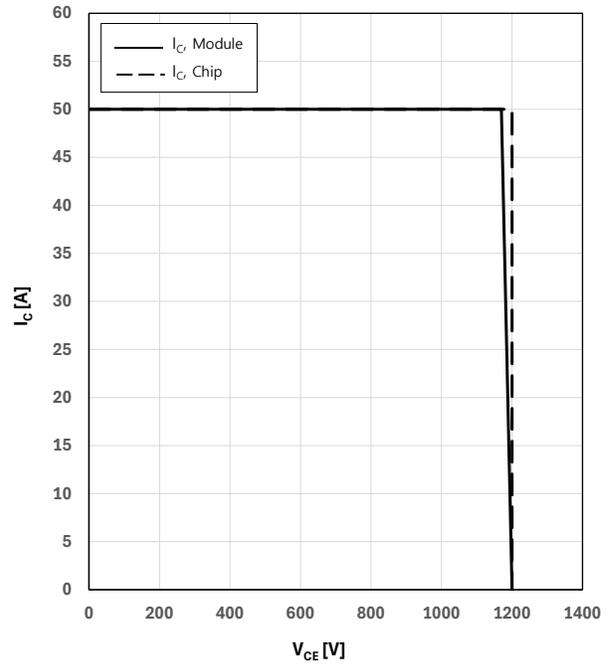
Gate charge characteristic (typical), IGBT, Inverter

$V_{GE}=f(Q_G)$
 $T_j=25^\circ\text{C}$, $I_C=25\text{A}$



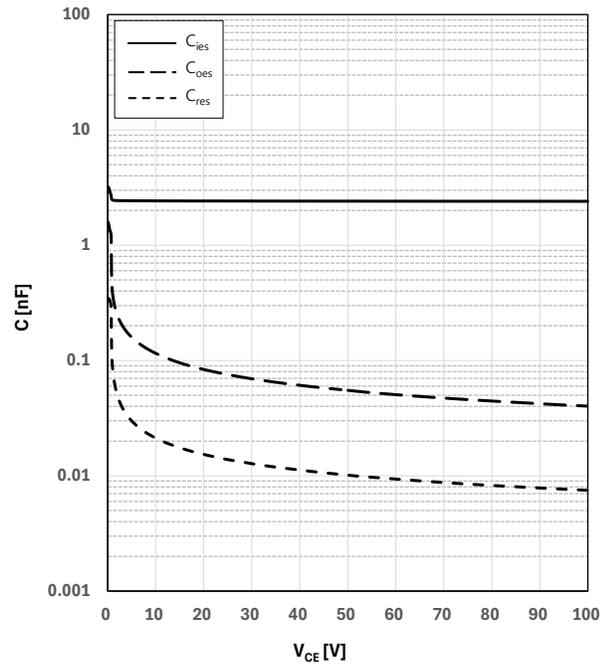
Reverse bias safe operating area (RBSOA), IGBT, Inverter

$I_C=f(V_{CE})$
 $R_{Goff}=6\Omega$, $V_{GE}=\pm 15\text{V}$, $T_j=175^\circ\text{C}$

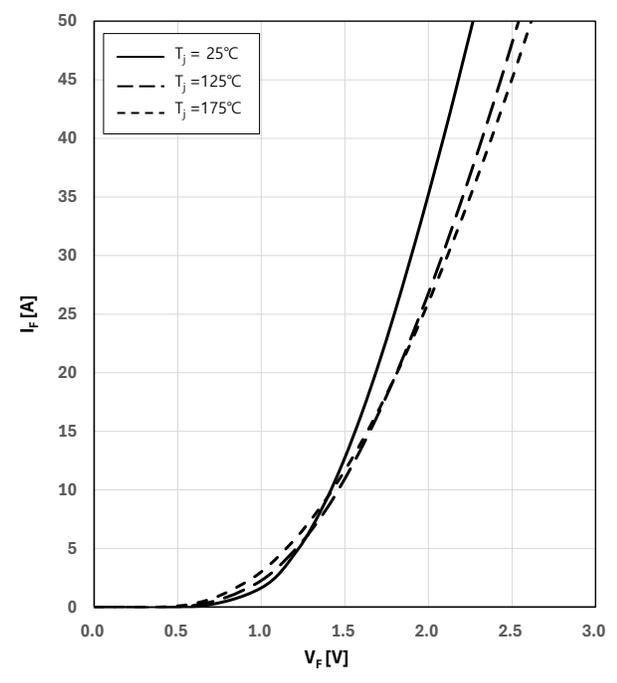


Capacity characteristic (typical), IGBT, Inverter

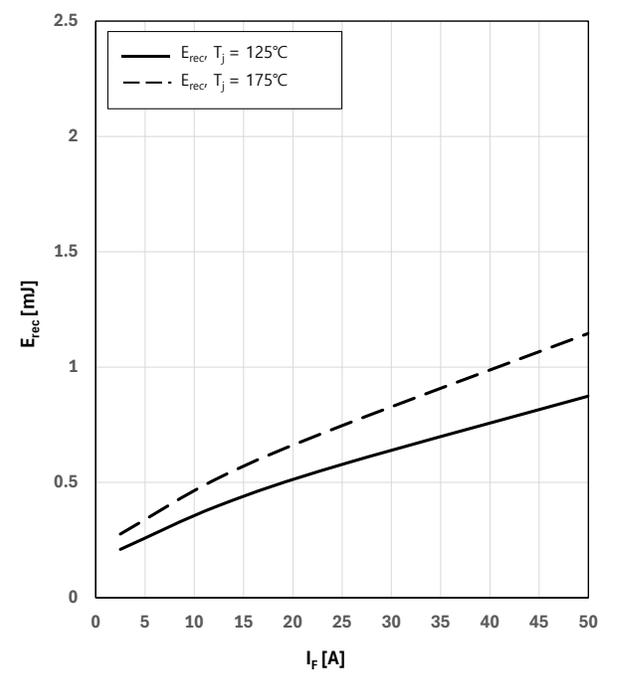
$C=f(V_{CE})$
 $f=100\text{kHz}$, $T_j=25^\circ\text{C}$, $V_{GE}=0\text{V}$



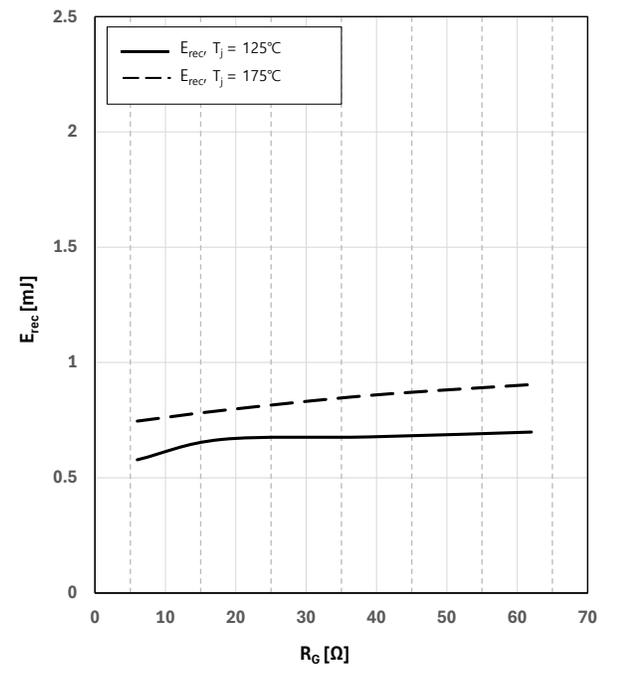
Forward characteristic (typical), Diode, Inverter
 $I_F=f(V_F)$



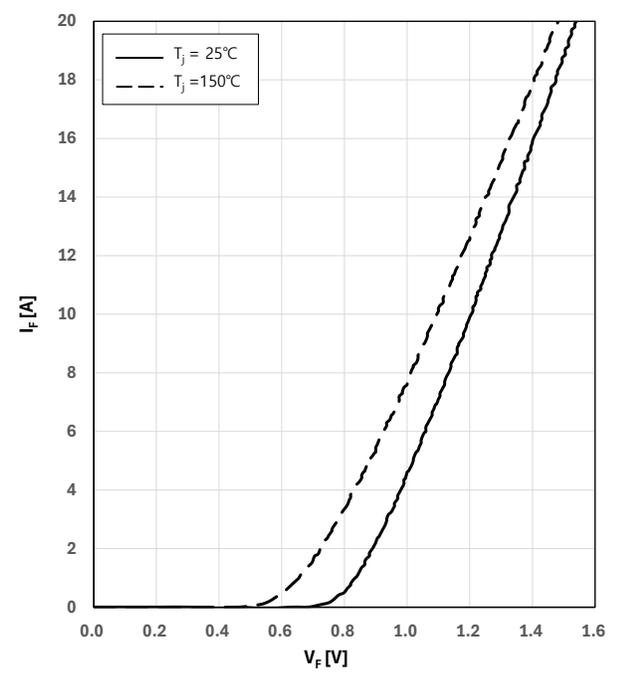
Switching losses (typical), Diode, Inverter
 $E_{rec}=f(I_F)$
 $R_{Gon}=6\Omega, V_{CE}=600V$



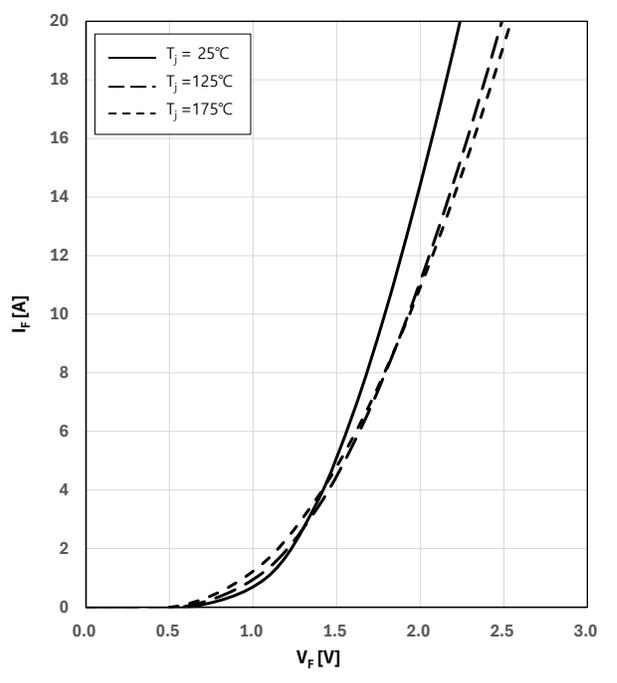
Switching losses (typical), Diode, Inverter
 $E_{rec}=f(R_G)$
 $V_{CE}=600V, I_F=25A$



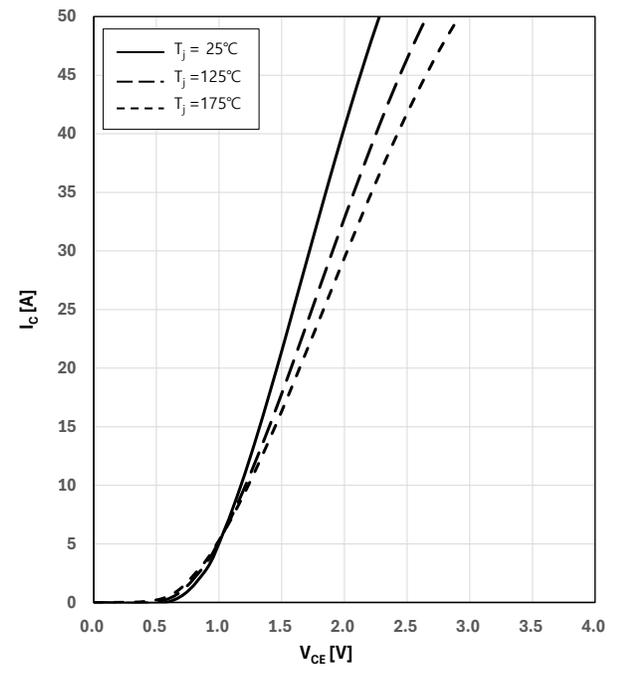
Forward characteristic (typical), Diode, Rectifier
 $I_F=f(V_F)$



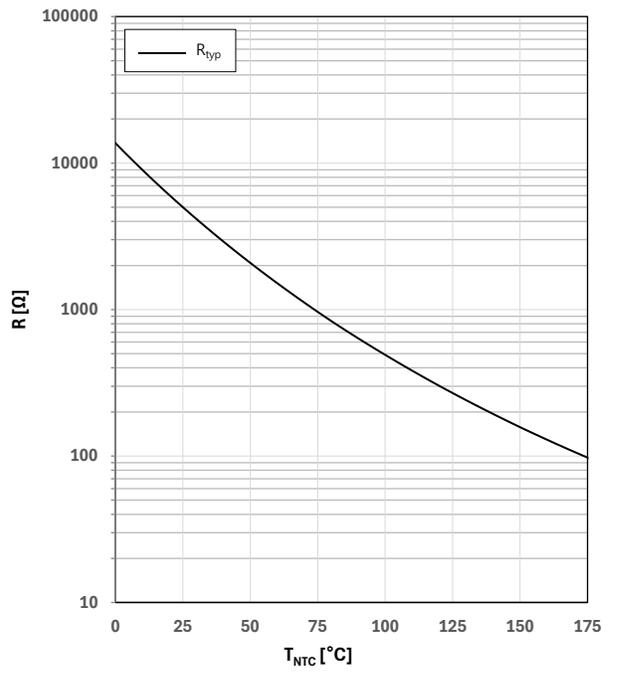
Forward characteristic (typical), Diode, Brake-Chopper
 $I_F=f(V_F)$



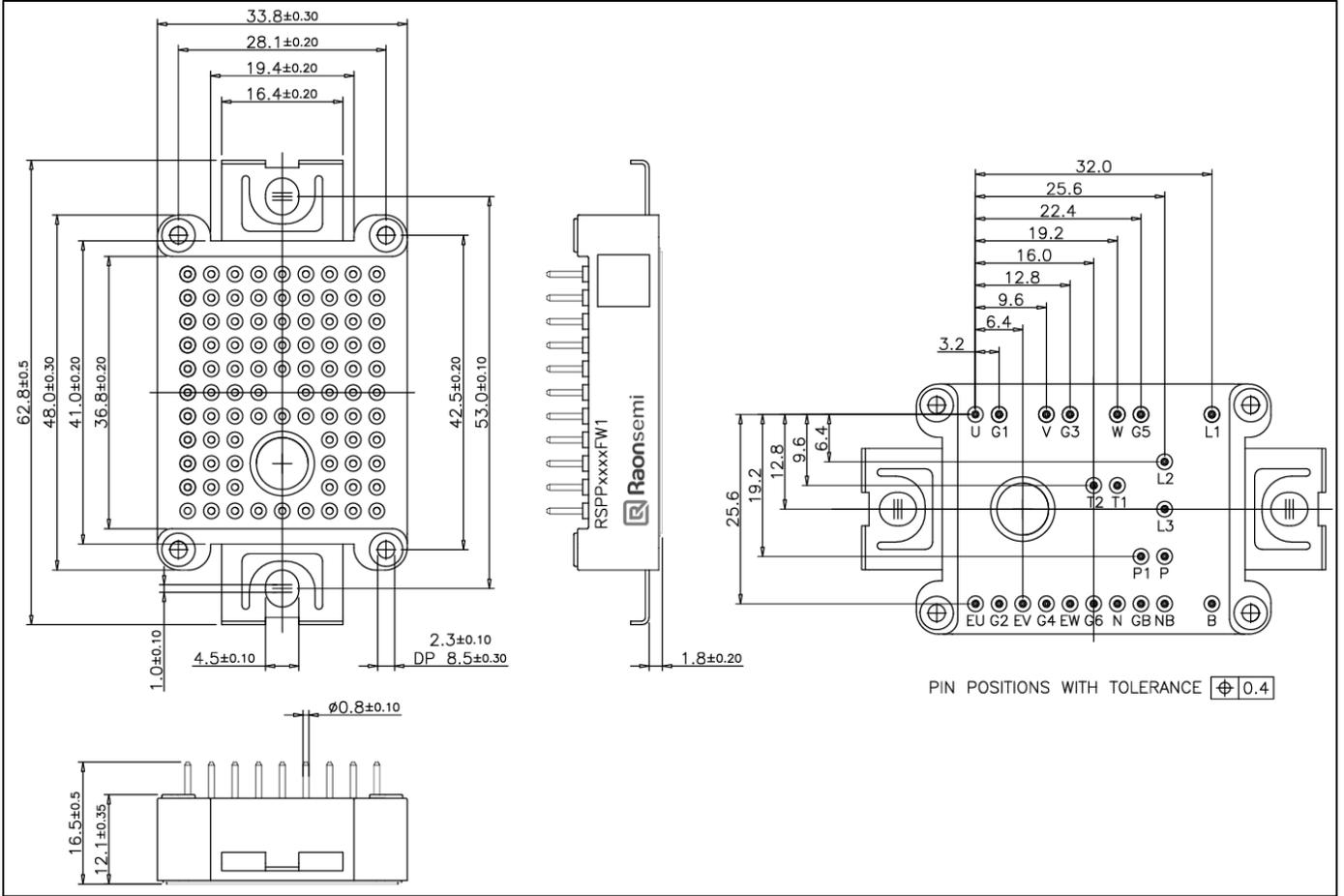
Output characteristic (typical), IGBT, Brake-Chopper
 $I_C=f(V_{CE})$
 $V_{GE}=15V$



Temperature characteristic (typical), NTC-Thermistor
 $R=f(T_{NTC})$



PACKAGE DIMENSIONS



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